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**Elektronikkomponenter –  
Fasta kondensatorer –  
Del 21: Gruppspecifikation för fasta keramiska  
flerskiktskondensatorer för ytmontering, Klass 1**

*Fixed capacitors for use in electronic equipment –  
Part 21: Sectional specification –  
Fixed surface mount multilayer capacitors of ceramic dielectric, Class 1*

Som svensk standard gäller europastandarden EN IEC 60384-21:2019. Den svenska standarden innehåller den officiella engelska språkversionen av EN IEC 60384-21:2019.

**Nationellt förord**

Europastandarden EN IEC 60384-21:2019

består av:

- **europastandardens ikraftsättningsdokument**, utarbetat inom CENELEC
- **IEC 60384-21, Third edition, 2019 - Fixed capacitors for use in electronic equipment - Part 21:  
Sectional specification - Fixed surface mount multilayer  
capacitors of ceramic dielectric, Class 1**

utarbetad inom International Electrotechnical Commission, IEC.

Tidigare fastställd svensk standard SS-EN 60384-21, utgåva 2, 2012, gäller ej fr o m 2022-03-05.

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ICS 31.060.10

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**EN IEC 60384-21**

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English Version

**Fixed capacitors for use in electronic equipment - Part 21:  
Sectional specification - Fixed surface mount multilayer  
capacitors of ceramic dielectric, Class 1  
(IEC 60384-21:2019)**

Condensateurs fixes utilisés dans les équipements  
électroniques - Partie 21: Spécification intermédiaire -  
Condensateurs multicouches fixes à diélectriques en  
céramique pour montage en surface, de classe 1  
(IEC 60384-21:2019)

Festkondensatoren zur Verwendung in Geräten der  
Elektronik - Teil 21: Rahmenspezifikation -  
Oberflächenmontierbare Vielschichtkeramik-  
Festkondensatoren, Klasse 1  
(IEC 60384-21:2019)

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European Committee for Electrotechnical Standardization  
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Europäisches Komitee für Elektrotechnische Normung

**CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels**

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Ref. No. EN IEC 60384-21:2019 E

## **European foreword**

The text of document 40/2639/FDIS, future edition 3 of IEC 60384-21, prepared by IEC/TC 40 "Capacitors and resistors for electronic equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 60384-21:2019.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2019-12-05
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2022-03-05

This document supersedes EN 60384-21:2012.

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CENELEC shall not be held responsible for identifying any or all such patent rights.

## **Endorsement notice**

The text of the International Standard IEC 60384-21:2019 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following note has to be added for the standard indicated:

IEC 60384-14      NOTE      Harmonized as EN 60384-14

**Annex ZA**  
(normative)

**Normative references to international publications  
with their corresponding European publications**

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cenelec.eu](http://www.cenelec.eu).

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60063	-	Preferred number series for resistors and capacitors	EN 60063	-
IEC 60068-1	2013	Environmental testing - Part 1: General and guidance	EN 60068-1	2014
IEC 60068-2-58	2015	Environmental testing - Part 2-58: Tests - Test Td: Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)	EN 60068-2-58	2015
+ A1	2017		+ A1	2018
IEC 60384-1	2016	Fixed capacitors for use in electronic equipment - Part 1: Generic specification	EN 60384-1	2016
IEC 61193-2	2007	Quality assessment systems - Part 2: Selection and use of sampling plans for inspection of electronic components and packages	EN 61193-2	2007
ISO 3	1973	Preferred numbers - Series of preferred numbers		-

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**INTERNATIONAL ELECTROTECHNICAL COMMISSION****FIXED CAPACITORS FOR USE IN ELECTRONIC EQUIPMENT –****Part 21: Sectional specification –  
Fixed surface mount multilayer capacitors  
of ceramic dielectric, Class 1****FOREWORD**

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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International Standard IEC 60384-21 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment.

This third edition cancels and replaces the second edition published in 2011. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) revision of the structure in accordance with ISO/IEC Directives, Part 2:2016 to the extent practicable, and for harmonizing with IEC 60384-22;
- b) deletion of the description on the permissible reactive power in 6.2.2 because it is not appropriate for the purposes of this document;

c) the dimensions of 0201M in Annex A have been added.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
40/2639/FDIS	40/2651/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 60384 series, published under the general title *Fixed capacitors for use in electronic equipment*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

**FIXED CAPACITORS FOR USE IN ELECTRONIC EQUIPMENT –****Part 21: Sectional specification –  
Fixed surface mount multilayer capacitors  
of ceramic dielectric, Class 1****1 Scope**

This part of IEC 60384 is applicable to fixed unencapsulated surface mount multilayer capacitors of ceramic dielectric, Class 1, for use in electronic equipment. These capacitors have metallized connecting pads or soldering strips and are intended to be mounted on printed boards, or directly onto substrates for hybrid circuits.

Capacitors for electromagnetic interference suppression are not included, but are covered by IEC 60384-14.

The object of this document is to prescribe preferred ratings and characteristics and to select from IEC 60384-1 the appropriate quality assessment procedures, tests and measuring methods and to give general performance requirements for this type of capacitor. Test severities and requirements prescribed in detail specifications referring to this sectional specification are of equal or higher performance levels; lower performance levels are not permitted.

**2 Normative references**

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60063, *Preferred number series for resistors and capacitors*

IEC 60068-1:2013, *Environmental testing – Part 1: General and guidance*

IEC 60068-2-58:2015, *Environmental testing – Part 2-58: Tests – Test Td – Test methods for solderability, resistance to dissolution of metallization and to soldering heat of surface mounting devices (SMD)*  
IEC 60068-2-58:2015/AMD1:2017

IEC 60384-1:2016, *Fixed capacitors for use in electronic equipment – Part 1: Generic specification*

IEC 61193-2:2007, *Quality assessment system – Part 2: Selection and use of sampling plans for inspection of electronic components and packages*

ISO 3:1973, *Preferred numbers – Series of preferred numbers*